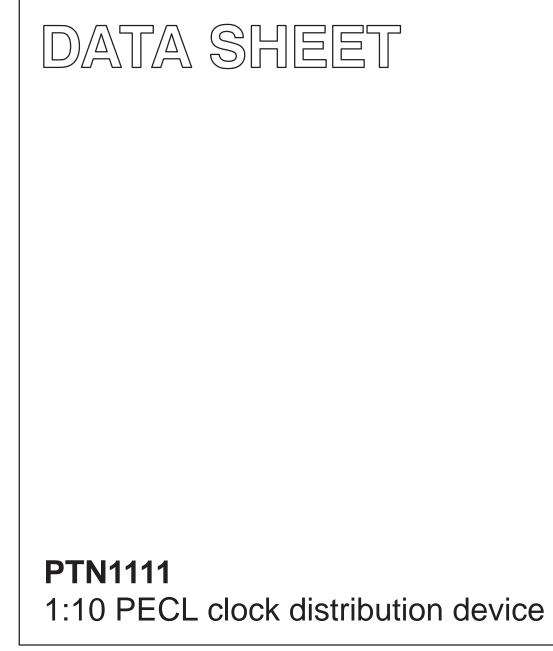
# INTEGRATED CIRCUITS



Product data

2001 Jun 19



**PTN1111** 

# 1:10 PECL clock distribution device

### FEATURES

- 80 ps part-to-part skew
- 20 ps output-to-output skew
- Differential design
- PECL inputs and outputs
- V<sub>BB</sub> reference output voltage available
- 75 kΩ input pulldown resistors
- Low voltage V<sub>CC</sub> range of 2.375 V to +3.8 V
- High signaling rate capability (above 1 GHz)
- Pin and function compatible to MC100EP111, MC100LVEP111
- Available in LQFP32 package

#### DESCRIPTION

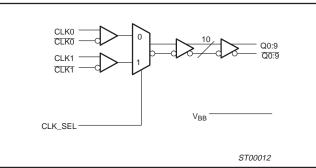
The PTN1111 is a low-skew, 1:10 PECL clock distribution device. One selected clock signal out of two selectable inputs is fanned out to 10 identical, precision time-aligned differential outputs.

The PTN1111 is provided with a  $V_{BB}$  reference voltage to allow for single-ended PECL input and with complementary clock inputs to allow for differential PECL input.

The main purpose and benefit of the PTN1111 is low skew: between individual outputs of a single PTN1111 (within-part skew or output-to-output skew) as well as measured from part-to-part. Within-part skew is realized by careful attention to internal layout and design of the PTN1111, whereas part-to-part skew is achieved by control and monitoring of relevant process parameters.

The PTN1111 can be used for high-performance, high-speed clock distribution in systems which utilize PECL as the primary signaling standard. Designers can take advantage of the device's performance to distribute clocks across a board or backplane, at an extremely high degree of time alignment, thereby affording system processors to achieve maximum utilization of the clock cycle.

#### LOGIC DIAGRAM

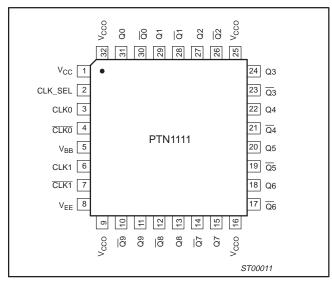


## **ORDERING INFORMATION**

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PTN1111BD	LQFP32	Plastic low profile quad flat package; 32 leads; body 7 x 7 x 1.4 mm	SOT358-1

#### 2001 Jun 19

### **PIN CONFIGURATION**



#### **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	V <sub>CC</sub>	Power supply voltage
2	CLK_SEL	Clock select input
3, 4	CLK0, CLK0	Differential PECL clock input pair
5	V <sub>BB</sub>	Voltage reference output
6, 7	CLK1, CLK1	Differential PECL clock input pair
8	$V_{EE}$	Ground
9, 16, 25, 32	Vcco	Output driver power supply voltages
10–15, 17–24, 26–31	Q0:9, <u>Q0:9</u>	Differential PECL output pairs

#### **ABSOLUTE MAXIMUM RATINGS**

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

SYMBOL	PARAMETER	LIMITS	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +4.6	V
ESDHBM	Electrostatic discharge (Human Body Model; 1.5 k $\Omega$ , 100 pF)	>2	kV
ESDMM	Electrostatic discharge (Machine Model; 0 kΩ, 200 pF)	>200	V

#### **RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage	2.375	3.8	V
V <sub>IR</sub>	Receiver input voltage	V <sub>EE</sub>	V <sub>CC</sub>	V
T <sub>amb</sub>	Operating ambient temperature range in free air	-40	+85	°C

#### DC ELECTRICAL CHARACTERISTICS

 $T_{amb} = -40^{\circ}C$  to +85°C unless otherwise specified;  $V_{CC} = 3.3$  V

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
V <sub>OH</sub>	Output HIGH voltage	2.275	2.345	2.420	V
V <sub>OL</sub>	Output LOW voltage	1.490	1.595	1.680	V
V <sub>IH</sub>	Input HIGH voltage	2.135	-	2.420	V
V <sub>IL</sub>	Input LOW voltage	1.490	-	1.825	V
V <sub>BB</sub>	Output reference voltage	1.92	-	2.04	V
V <sub>CC</sub>	Power supply voltage	2.375	-	3.8	V
I <sub>IH</sub>	Input HIGH current	-	-	150	μΑ
I <sub>EE</sub>	Power supply current, internal	-	80	120	mA
I <sub>CC</sub>	Power supply current including load: 50 $\Omega$ to V_CC – 2.0 V	-	340	-	mA

NOTE:

1. These values are for  $V_{CC}$  = 3.3 V; PECL level specifications are referenced to  $V_{CC}$  and will track 1:1 with variation of  $V_{CC}$ .

#### AC ELECTRICAL CHARACTERISTICS

 $T_{amb}$  = –40°C to +85°C unless otherwise specified;  $V_{CC}$  =  $V_{CCmin}$  to  $V_{CCmax;}$   $V_{EE}$  = 0 V

SYMBOL	PARAMETER		TYP	MAX	UNIT
t <sub>PLH</sub>	Propagation delay input (differential) to output	-	400	680	ps
t <sub>PHL</sub>	Propagation delay input (single-ended) to output		400	680	ps
	Clock output skew, within device		20	40	ps
t <sub>skew</sub>	Clock output skew, part-to-part	-	80	110	ps
	Clock output pulse skew	-	50	160	ps
f <sub>MAX</sub>	Maximum input frequency	-	1.5	-	GHz
t <sub>Pclk_set</sub>	Propagation delay CLK_SEL transition to stable Qn/Qn output	-	5	10	ns
V <sub>PP</sub> <sup>1</sup>	Input swing 0.5 0.8 1.3		1.3	V	
t <sub>r</sub> /t <sub>f</sub>	Output rise/fall time at 20% and 80% intersects	– 200 – ps			ps

NOTE:

1. Required to maintain AC specifications. Actual device accepts  $V_{\text{PP}}$  of 100 mV or higher.

PTN1111

## 1:10 PECL clock distribution device

of 0.25 mm maxir	num per side are	not included.			
OUTLINE REFERENCES					
IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
6E03	MS-026				<del>-99-12-27-</del> 00-01-19
	IEC	REFER IEC JEDEC	IEC JEDEC EIAJ	REFERENCES	REFERENCES EUROPEAN PROJECTION   IEC JEDEC EIAJ

#### LQFP32: plastic low profile quad flat package; 32 leads; body 7 x 7 x 1.4 mm SOT358-1 Ду X А 24 25 16 ΖE +е Ė НЕ $(A_3)$ 12 ⊕ wM ⊥ ∎<sub>bp</sub> pin 1 index 32 9 detail X 8 H ΖD = v 🕅 A + <del>| w</del> M bp D ► B HD = v 🕅 B 2.5 5 mm 0 scale DIMENSIONS (mm are the original dimensions) А Z<sub>D</sub><sup>(1)</sup> Z<sub>E</sub><sup>(1)</sup> D<sup>(1)</sup> E<sup>(1)</sup> UNIT θ С $H_D$ ΗE L ۷ w у $A_1$ $A_2$ $A_3$ bp е Lp max. 7.1 6.9 1.45 7.1 6.9 0.20 0.4 0.18 9.15 9.15 0.75 0.9 0.9 7° 0.25 0.8 1.0 0.25 0.1 mm 1.60 0.2 0° 0.05 1.35 0.3 0.12 8.85 8.85 0.45 0.5 0.5

## PTN1111

## 1:10 PECL clock distribution device

## **PTN1111**

#### Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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